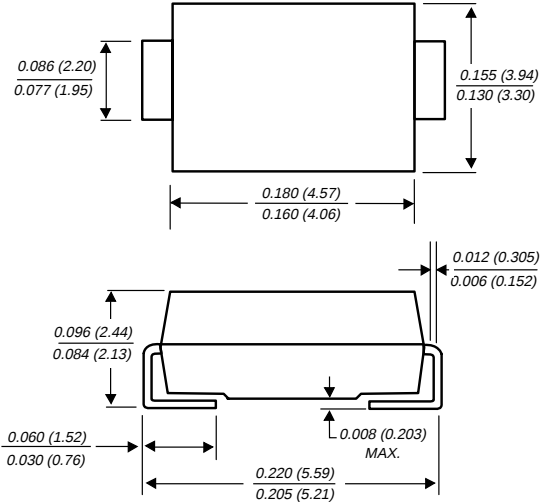


S2A THRU S2M

SURFACE MOUNT GLASS PASSIVATED SILICON RECTIFIER

Reverse Voltage - 50 to 1000 Volts Forward Current - 1.5 Amperes

DO-214AA MODIFIED J-BEND



Dimensions in inches and (millimeters)

FEATURES

- ◆ Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Low profile package
- ◆ Built-in strain relief, ideal for automated placement
- ◆ Glass passivated chip junction
- ◆ High temperature soldering: 250°C/10 seconds at terminals



MECHANICAL DATA

Case: JEDEC DO-214AA molded plastic body over passivated chip

Terminals: Solder plated, solderable per MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Weight: 0.003 ounce, 0.093 gram

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

	SYMBOLS	S2A	S2B	S2D	S2G	S2J	S2K	S2M	UNITS
Device marking code		SA	SB	SD	SG	SJ	SK	SM	
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum average forward rectified current at T _L =100°C	I _(AV)	1.5							Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) T _L =100°C	I _{FSM}	50.0							Amps
Maximum instantaneous forward voltage at 1.5 A	V _F	1.15							Volts
Maximum DC reverse current at Rated DC blocking voltage T _A =25°C T _A =125°C	I _R	1.0 125.0							μA
Typical reverse recovery time (NOTE 1)	t _{rr}	2.0							μs
Typical junction capacitance (NOTE 2)	C _J	30.0							pF
Typical thermal resistance (NOTE 3)	R _{θJA} R _{θJL}	53.0 16.0							°C/W
Operating and storage temperature range	T _J , T _{STG}	-55 to +150							°C

NOTES:

- (1) Reverse recovery test conditions: I_F=0.5A, I_R=1.0A, I_{rr}=0.25A
- (2) Measured at 1.0 MHz and applied reverse voltage of 4.0 Volts
- (3) Thermal resistance from junction to ambient and junction to lead
P.C.B. mounted on 0.27 x 0.27" (7.0 x 7.0mm) copper pad areas

RATINGS AND CHARACTERISTIC CURVES S2A THRU S2M

FIG. 1 - FORWARD CURRENT DERATING CURVE

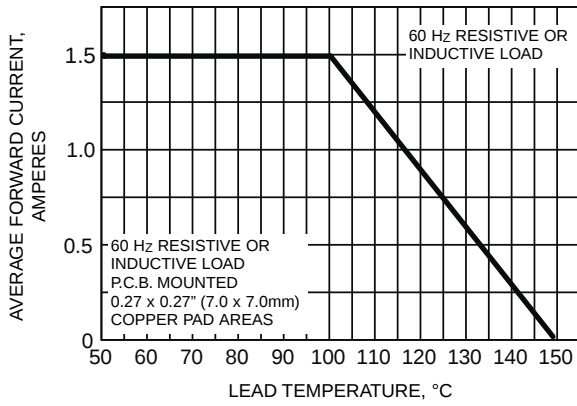


FIG. 2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

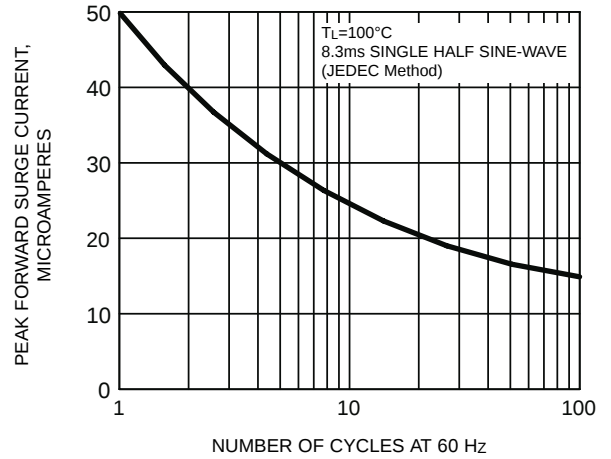


FIG. 3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

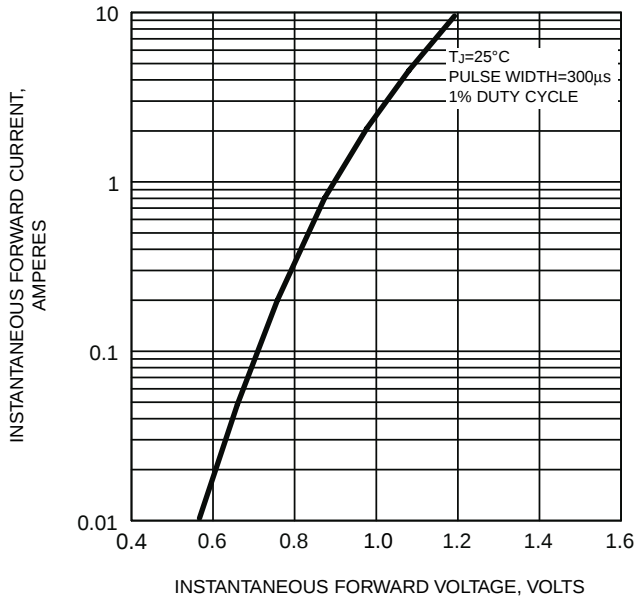


FIG. 4 - TYPICAL REVERSE CHARACTERISTICS

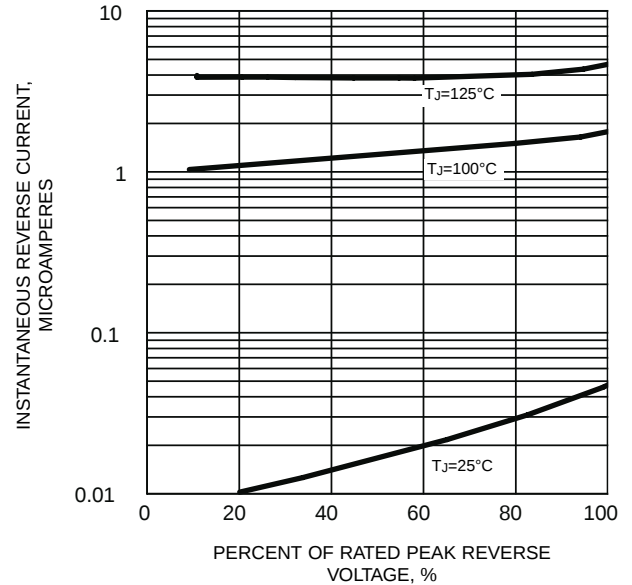


FIG. 5 - TYPICAL JUNCTION CAPACITANCE

